first and second tuners are electrically shielded from each other by a grounding conductor layer provided within the multi-layer board.

- 3. (Amended) The digital broadcast receiving tuner according to Claim 2, wherein the first and second tuners each comprise a high-frequency unit and a demodulation unit, and wherein the high-frequency unit of the first tuner and the demodulation unit of the second tuner are arranged at a first position, and the demodulation unit of the first tuner and the high-frequency unit of the second tuner are arranged at a second position, the first and second positions being opposite to each other with the multi-layer board interposed therebetween.
- wherein the multi-layer board comprises at least the two grounding conductor layers between lamination layers, each grounding conductive layer has deletion units and a first remainder, the deletion units of a first grounding conductive layer more proximate to a particular high-frequency unit of one of the first and second tuners than a second grounding conductive layer are arranged more proximate to the particular high-frequency unit than the first remainder of the one of the first and second tuners and the first remainder of the first grounding conductive layer is arranged more proximate to a particular demodulation unit of the one of the first and second tuners than the deletion units of the one of the first and second tuners to thereby increase a facing distance between the wiring pattern of the particular high-frequency unit and the corresponding first remainder.
  - 5. (Amended) The digital broadcast receiving tuner according to Claim 4, wherein each high-frequency unit comprises an IC component having a direct conversion unit including an oscillator and a mixer, and each grounding conductor layer has a second remainder that opposes a lower portion of the corresponding IC component.
  - 6. (New) The digital broadcast receiving tuner according to Claim 5, wherein the second remainder of each grounding conductor layer is disposed between deletion units of the corresponding grounding conductor layer.